

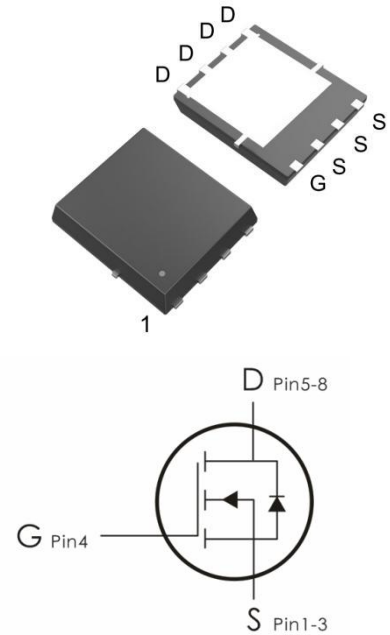
## Description:

This N-Channel MOSFET uses advanced SGT technology and design to provide excellent  $R_{DS(on)}$  with low gate charge.

It can be used in a wide variety of applications.

## Features:

- 1)  $V_{DS}=100V, I_D=60A, R_{DS(ON)} < 10m\ \Omega @ V_{GS}=10V$  (Typ:  $8.6m\ \Omega$ )
- 2) Low gate charge.
- 3) Green device available.
- 4) Advanced high cell density trench technology for ultra low  $R_{DS(ON)}$ .
- 5) Excellent package for good heat dissipation.
- 6) MSL3



## Package Marking and Ordering Information:

Part NO.	Marking	Package	Packing
DON60N10-L	60N10-L	DFN5*6-8	5000 pcs/Reel

## Absolute Maximum Ratings: ( $T_C=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Ratings	Units
$V_{DS}$	Drain-Source Voltage	100	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Continuous Drain Current	60	A
	Continuous Drain Current- $T_C=100^\circ C$	42	
$P_D$	Power Dissipation	54	W
$I_{DM}$	Pulsed Drain Current <sup>1</sup>	240	A
$E_{AS}$	Single pulse avalanche energy <sup>2</sup>	71	mJ
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55-+150	$^\circ C$

## Thermal Characteristics:

Symbol	Parameter	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case	2.3	$^\circ C/W$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	60	$^\circ C/W$

**Electrical Characteristics:** ( $T_C=25^{\circ}\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\ \mu\text{A}$	100	---	---	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{GS}=0V, V_{DS}=100V$	---	---	1	$\mu\text{A}$
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0A$	---	---	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(th)}$	Gate-Source Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\ \mu\text{A}$	1	1.8	2.5	V
$R_{DS(on)}$	Drain-Source On Resistance <sup>3</sup>	$V_{GS}=10V, I_D=10A$	---	8.6	10	$\text{m}\Omega$
		$V_{GS}=4.5V, I_D=10A$	---	11	15	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS}=50V, V_{GS}=0V, f=1\text{MHz}$	---	1615	---	pF
$C_{oss}$	Output Capacitance		---	441	--	
$C_{rss}$	Reverse Transfer Capacitance		---	7.8	---	
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-On Delay Time	$V_{DD}=50V, R_D=5\ \Omega$ $R_{ENG}=10\ \Omega, V_{GS}=10V$	---	9.4	---	ns
$t_r$	Rise Time		---	4.2	---	ns
$t_{d(off)}$	Turn-Off Delay Time		---	25.2	---	ns
$t_f$	Fall Time		---	4.2	---	ns
$Q_g$	Total Gate Charge		$V_{GS}=10V, V_{DD}=50V,$ $I_D=20A$	---	31.5	---
$Q_{gs}$	Gate-Source Charge	---		3.1	---	nC
$Q_{gd}$	Gate-Drain "Miller" Charge	---		14.7	---	nC
<b>Drain-Source Diode Characteristics</b>						
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0V, I_{SD}=20A$	---	0.9	1.3	V
$I_S$	Continuous Drain Current	$V_D=V_G=0V$	---	---	60	A
$I_{SM}$	Pulsed Drain Current		---	---	240	A

**Notes:**

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
2. EAS condition:  $T_J=25^{\circ}\text{C}$ ,  $V_{DD}=50V$ ,  $V_G=10V$ ,  $L=0.5\text{mH}$
3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$ , Duty Cycle $\leq 0.5\%$

Typical Characteristics: ( $T_c=25^\circ\text{C}$  unless otherwise noted)

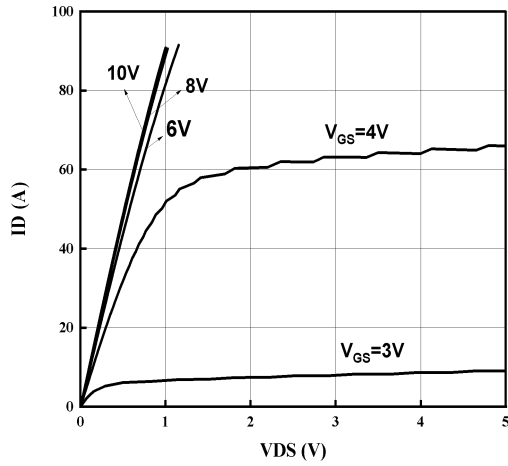


Fig1. Typical Output Characteristics

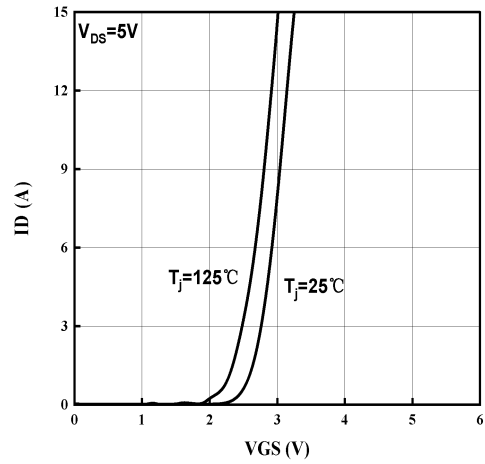


Fig2. Typical Transfer Characteristics

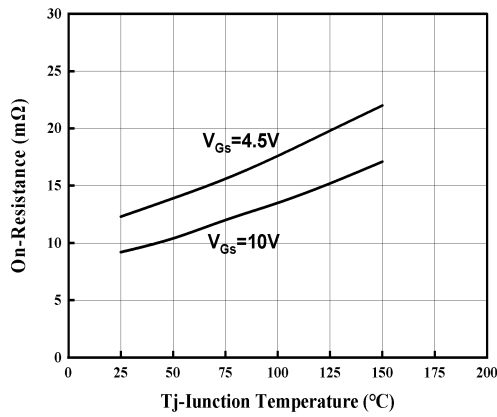


Fig3. On-Resistance Vs. Temperature

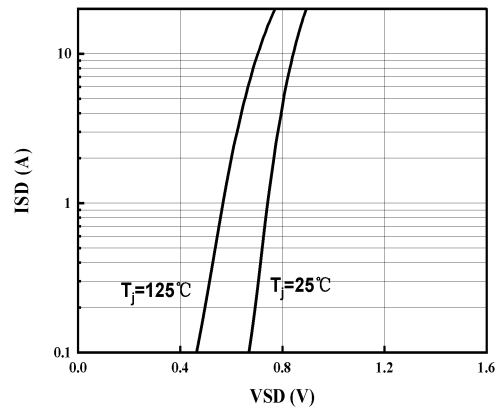


Fig4. Typical Source-Drain Diode Forward Voltage

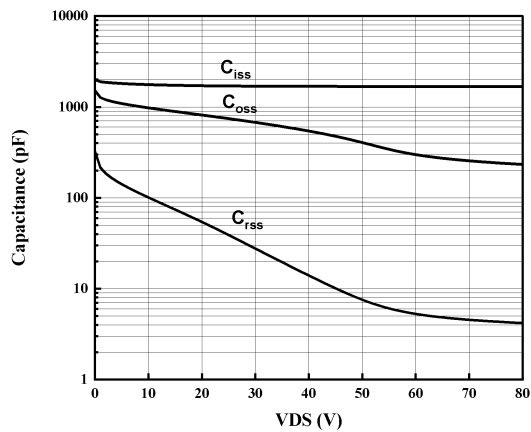


Fig5. Typical Capacitance

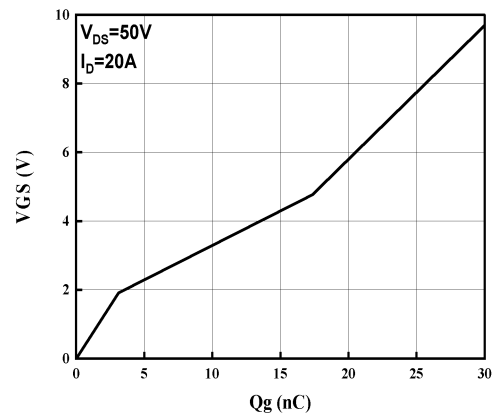


Fig6. Typical Gate Charge

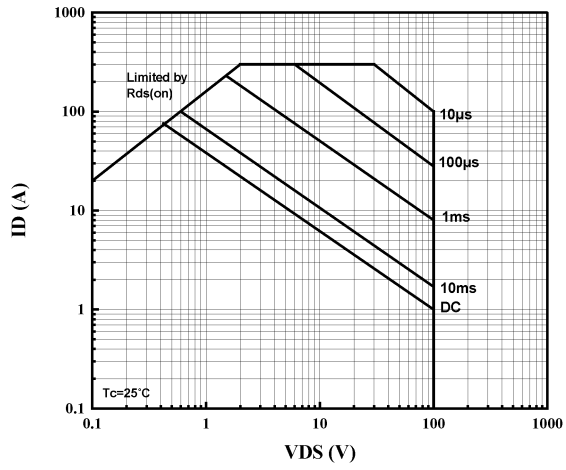


Fig7. Safe Operating Area

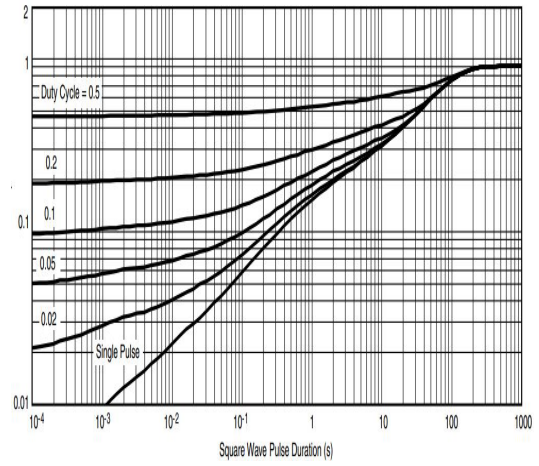
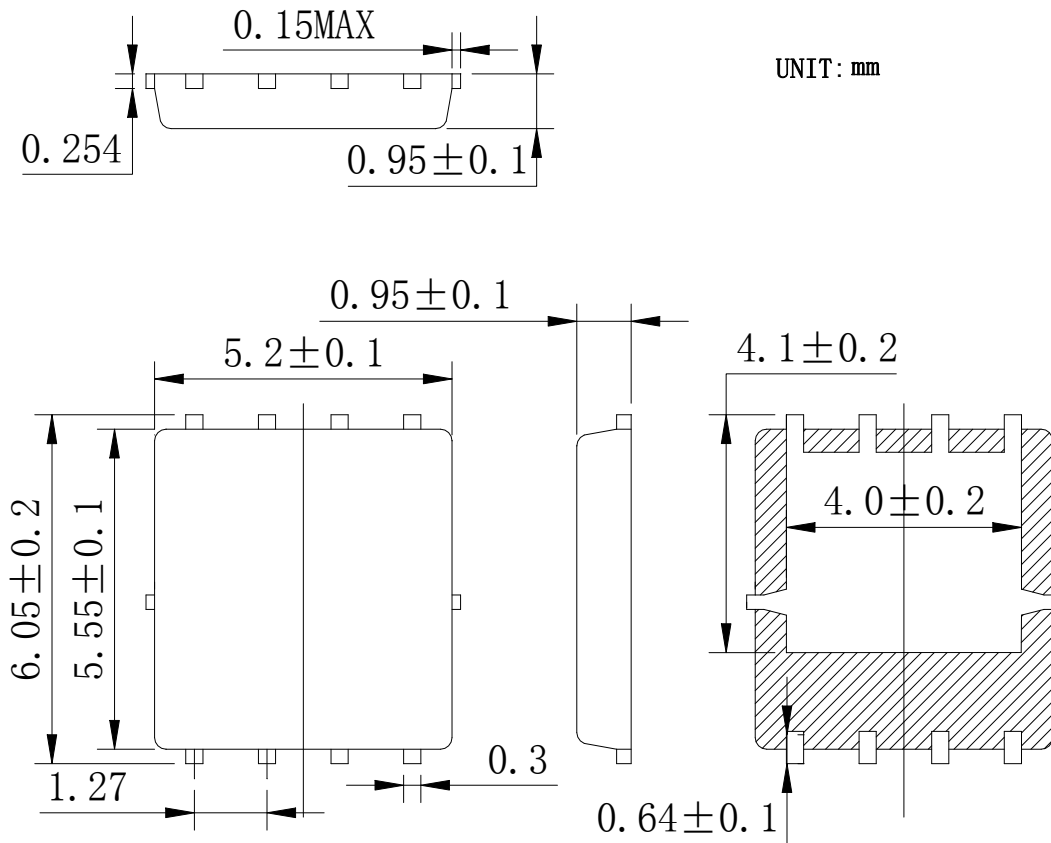


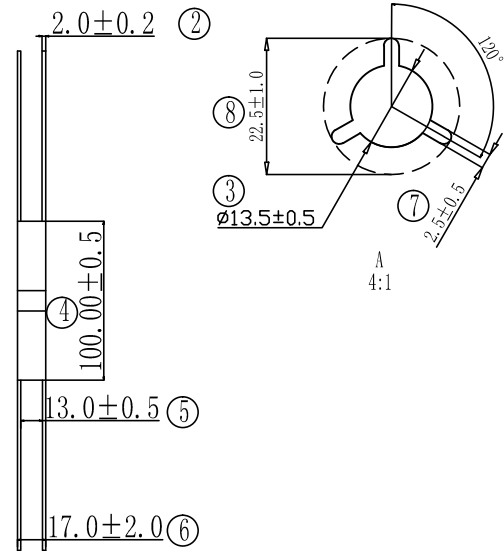
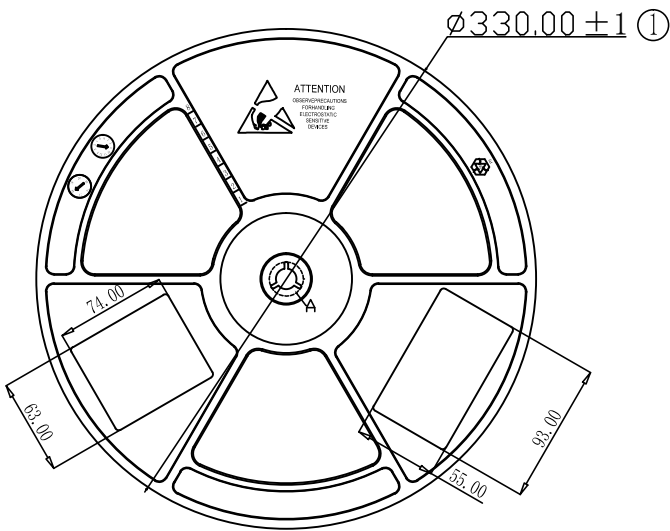
Fig8. Normalized transient thermal impedance

## DFN5x6-8 Package Information:

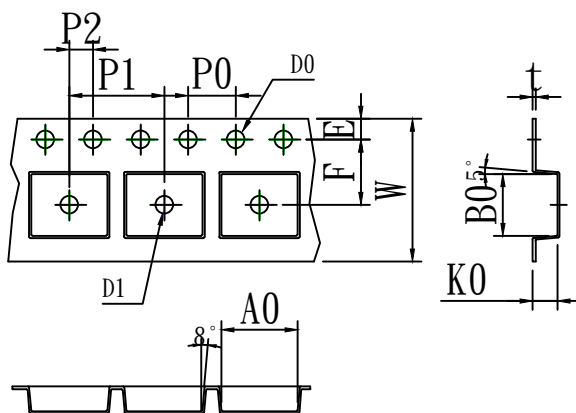


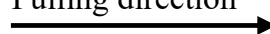
## Tape & Reel Information

Dimensions in mm



Symbol	A0	B0	K0	D0	D1	P0	P1	10*P0
Spec	$6.15 \pm 0.10$	$5.40 \pm 0.10$	$1.30 \pm 0.10$	$1.55 \pm 0.10$	$1.55 \pm 0.10$	$4.00 \pm 0.10$	$8.00 \pm 0.10$	$40.00 \pm 0.10$
Symbol	W	E	F	P2	t			
Spec	$12.00 \pm 0.10$	$1.75 \pm 0.10$	$5.50 \pm 0.10$	$2.00 \pm 0.10$	$0.20 \pm 0.05$			



Pulling direction 

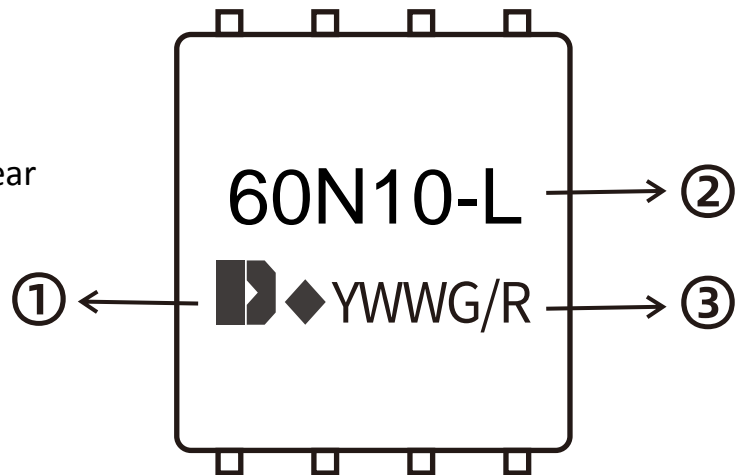
## Marking Information:

- ①. Doingter LOGO
- ②. Part NO.
- ③. Date Code(YWWG / R)

Y : Year Code , last digit of the year

WW : Week Code(01-53)


G/R : G(Green) /R(Lead Free)



## Previous Version

Version	Date	Subjects (major changes since last revision)
1.0	2024-09-19	Release of final version

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